

# DuPont™ EKC922™

## Universal Photoresist Remover

### Product Description

DuPont™ EKC922™ universal photoresist remover is an organic based photoresist remover formulated to remove positive and negative photoresist and other organic compounds where an ultra clean surface is required.

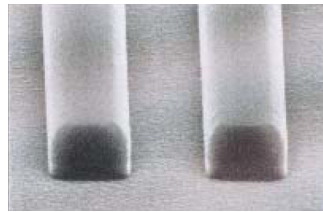
### Advantages

- No phenol or chlorinated solvents
- Extended bath life
- Compatible with III to V compound semiconductors (i.e., GaAs, InP and SiGe)
- Safe to use on semi-cured polyimides
- Compatible with conventional semiconductor materials

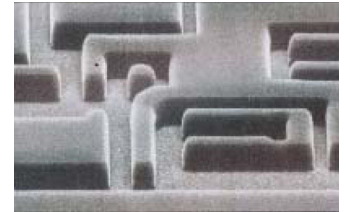
### Typical Applications

Bulk photoresist removal for:

- MEMS
- Backlap process
- Chrome photomasks
- Metal carriers
- Ink dot removal
- Integrated circuits
- Hybrid device
- III-V compound semiconductors
- Spinner parts



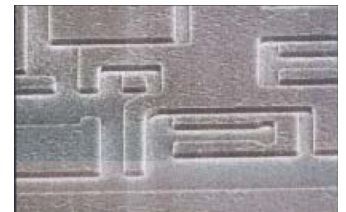
After etch



After etch



After DuPont™ EKC922™/85 °C/30 min



After DuPont™ EKC922™/85 °C/15 min



[ekctech.dupont.com](http://ekctech.dupont.com)

For more information on DuPont™ EKC922™ or other DuPont products, please visit our website.

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**CAUTION:** Do not use in medical applications involving permanent implantation in the human body. For other medical applications, see "DuPont Medical Caution Statement," H-50102-5 and "DuPont Policy Regarding Medical Applications" H-50103-5.

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